

Data Sheet July 1999 FN4592.1

# Radiation Hardened Quad Differential Line Receiver

Intersil's Satellite Applications Flow<sup>TM</sup> (SAF) devices are fully tested and guaranteed to 100kRAD total dose. These QML Class T devices are processed to a standard flow intended to meet the cost and shorter lead-time needs of large volume satellite manufacturers, while maintaining a high level of reliability.

The Intersil HS-26C32RH-T is a Quad Differential Line Receiver designed for digital data transmission over balanced lines and meets the requirements of EIA Standard RS-422. Radiation Hardened CMOS processing assures low power consumption, high speed, and reliable operation in the most severe radiation environments.

The HS-26C32RH-T has an input sensitivity of 200mV (typ). over the common mode input voltage range of  $\pm 7$ V. The receivers are also equipped with input fail safe circuitry, which causes the outputs to go to a logic "1" when the inputs are open. Enable and Disable functions are common to all four receivers.

# **Specifications**

Specifications for Rad Hard QML devices are controlled by the Defense Supply Center in Columbus (DSCC). The SMD numbers listed below must be used when ordering.

Detailed Electrical Specifications for the HS-26C32RH-T are contained in SMD 5962-95689. A "hot-link" is provided from our website for downloading.

www.intersil.com/spacedefense/newsafclasst.asp

Intersil's Quality Management Plan (QM Plan), listing all Class T screening operations, is also available on our website.

www.intersil.com/quality/manuals.asp

# **Ordering Information**

ORDERING NUMBER	PART NUMBER	TEMP. RANGE (°C)
5962R9568901TEC	HS1-26C32RH-T	-55 to 125
HS1-26C32RH/Proto	HS1-26C32RH/Proto	-55 to 125
5962R9568901TXC	HS9-26C32RH-T	-55 to 125
HS9-26C32RH/Proto	HS9-26C32RH/Proto	-55 to 125

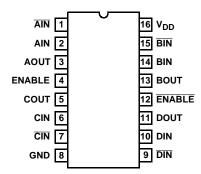
NOTE: Minimum order quantity for -T is 150 units through distribution, or 450 units direct.

#### **Features**

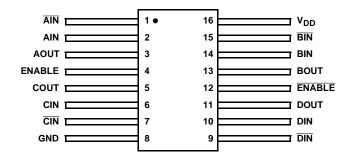
- QML Class T, Per MIL-PRF-38535
- Radiation Performance
  - Gamma Dose . . . . . . . . . . . . . . . . . 1 x 10<sup>5</sup> RAD(Si)
  - SEU and SEL . . . . . . . Immune to 100MeV/mg/cm<sup>2</sup>
- EIA RS-422 Compatible Inputs
- · CMOS Compatible Enable Inputs
- Input Fail Safe Circuitry
- · High Impedance Inputs when Disabled or Powered Down
- · Low Power Dissipation 138mW Standby (Max)
- Single 5V Supply
- Full -55°C to 125°C Military Temperature Range

#### **Pinouts**

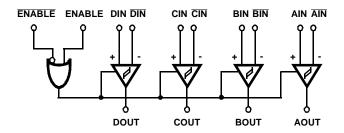
HS1-26C32RH-T (SBDIP), CDIP2-T16 TOP VIEW



#### HS9-26C32RH-T (FLATPACK), CDFP4-F16 TOP VIEW



# Functional Diagram



### TRUTH TABLE

	INPUTS			OUTPUT
DEVICE POWER ON/OFF	ENABLE	ENABLE	INPUT	ОПТ
ON	0	1	Х	HI-Z
ON	1	Х	VID ≥ VTH (Max)	1
ON	1	Х	VID ≤ VTH (Min)	0
ON	Х	0	VID ≥ VTH (Max)	1
ON	Х	0	VID ≤ VTH (Min)	0
ON	1	Х	Open	1
ON	Х	0	Open	1

#### Die Characteristics

#### **DIE DIMENSIONS:**

 $2140\mu m\ x\ 3290\mu m\ x\ 533\mu m\ \pm 25.4\mu m$  (85 x 130 x 21mils  $\pm 1mil$ )

#### METALLIZATION:

M1: Mo/Tiw

Thickness: 5800Å M2: Al/Si/Cu

Thickness: 10kÅ ±1kÅ

### **SUBSTRATE POTENTIAL:**

Internally connected to V<sub>DD</sub>. May be left floating.

#### **BACKSIDE FINISH:**

Silicon

#### **PASSIVATION:**

Type: SiO<sub>2</sub>

Thickness: 8kÅ ±1kÅ

# WORST CASE CURRENT DENSITY:

< 2.0e5 A/cm<sup>2</sup>

#### TRANSISTOR COUNT:

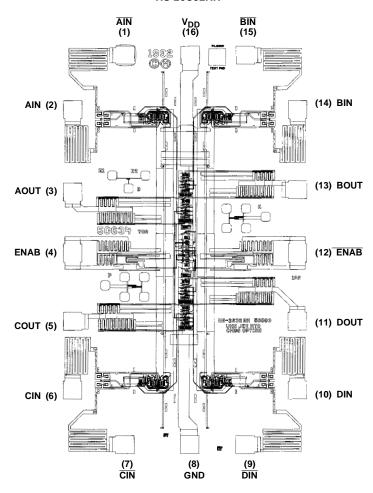
315

#### PROCESS:

Radiation Hardened CMOS, AVLSI

## Metallization Mask Layout

#### HS-26C32RH



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